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NESTED CUTTING BOARDS

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(US)

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USPC D7/698

(58)

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See application file for complete search history.

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Primary Examiner — Ricky Pham

(57)**CLAIM**

The ornamental design for nested cutting boards, as shown and described.

DESCRIPTION

FIG. 1 is an exploded perspective view of the nested cutting boards of my new design showing the primary cutting board, the secondary cutting board and the tertiary cutting board;

FIG. 2 is a perspective view of the bottom of the nested cutting boards showing, the bumper pads, the tertiary cutting board nested within the secondary cutting board, and the secondary and tertiary cutting boards nested within the primary cutting board;

FIG. 3 is a cross-sectional view taken through line 3-3 of FIGS. 2 & 7 of the nested cutting boards of my design, showing the bumper pads, the tertiary cutting board nested within the secondary cutting board, and the secondary and tertiary cutting boards nested within the primary cutting board;

FIG. 4 is a front elevational view of the nested cutting boards and bumper pads of my design, the rear elevational view being a mirror image thereof;

FIG. 5 is a left elevational view of the nested cutting boards and bumper pads of my design, the right elevational view being a mirror image thereof;

FIG. 6 is a top plan view of the nested cutting boards of my design;

FIG. 7 is a bottom plan view of the nested cutting boards of my new design showing the bumper pads, the tertiary cutting board nested within the secondary cutting board, and the secondary and tertiary cutting boards nested with the primary cutting board;

FIG. 8 is a front elevational view of the secondary cutting board of my design, the rear elevational view of the secondary cutting board being a mirror image thereof;

FIG. 9 is a left side elevational view of the secondary cutting board of my design, the right side elevational view of the secondary cutting board being a mirror image thereof;

FIG. 10 is a top plan view of the secondary cutting board of my design;

FIG. 11 is a bottom plan view of the secondary cutting board of my design;

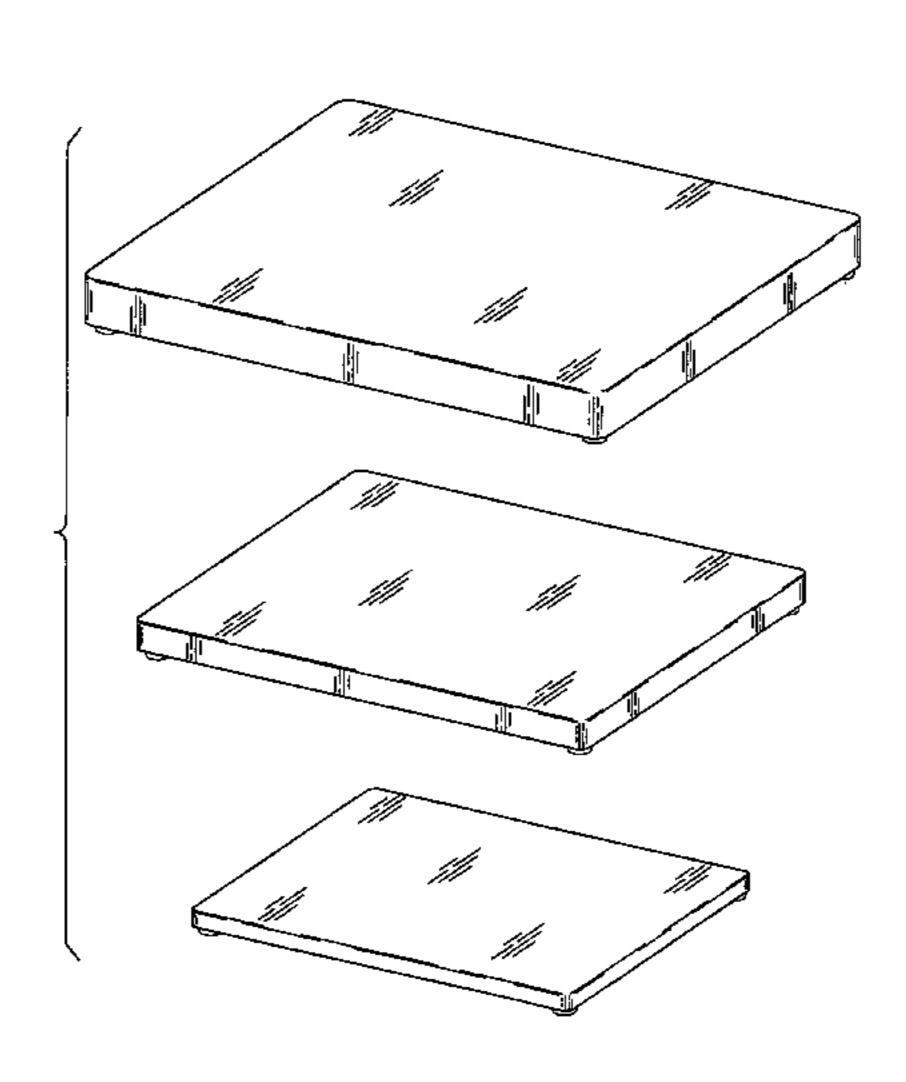
FIG. 12 is a front elevational view of the tertiary cutting board of my design, the rear elevational view of the tertiary cutting board being a mirror image thereof;

FIG. 13 is a left side elevational view of the tertiary cutting board of my design, the right side elevational view of the tertiary cutting board being a mirror image thereof;

FIG. 14 is a top plan view of the tertiary cutting board of my design; and,

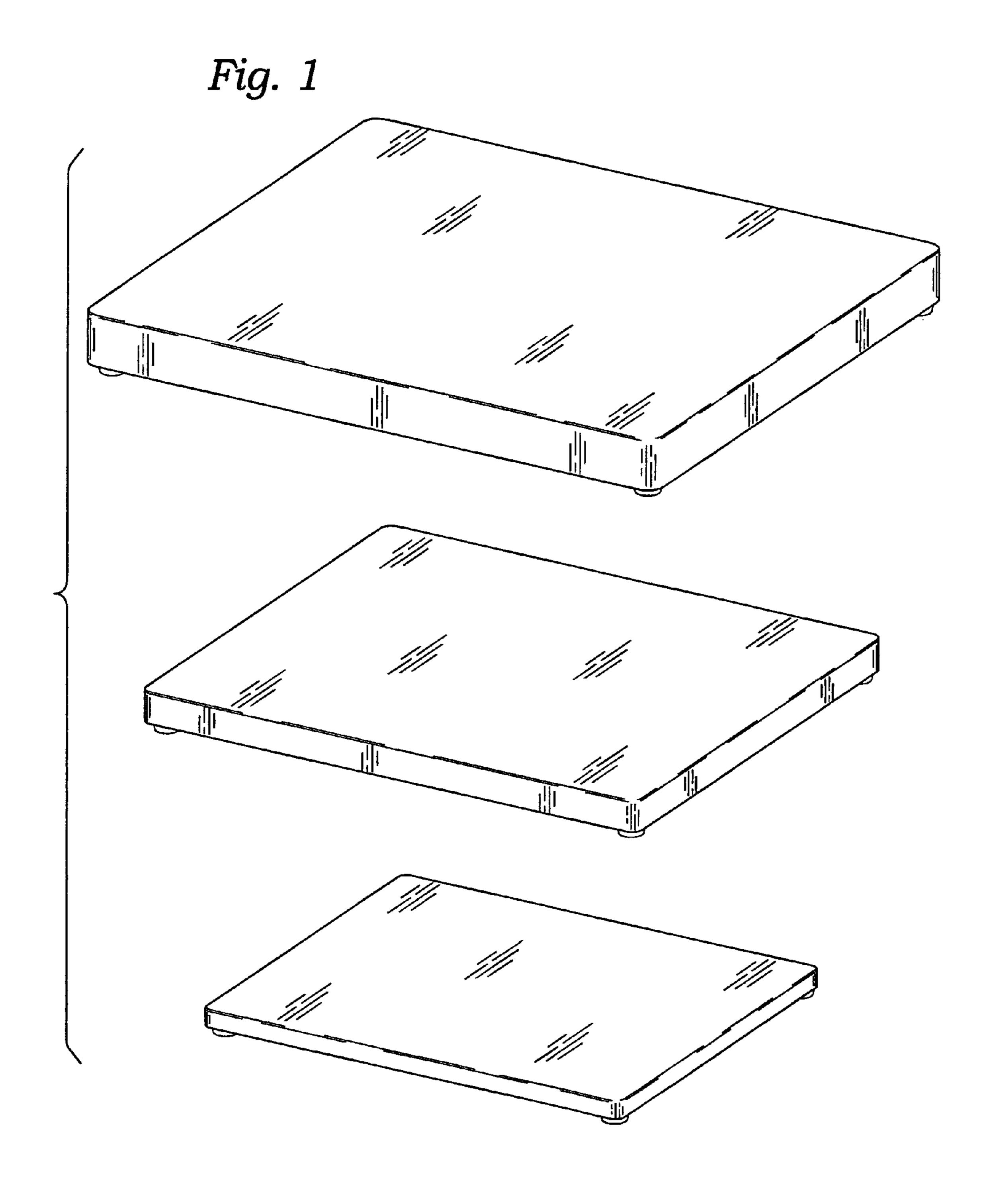
FIG. 15 is a bottom plan view of the tertiary cutting board of my design.

1 Claim, 5 Drawing Sheets



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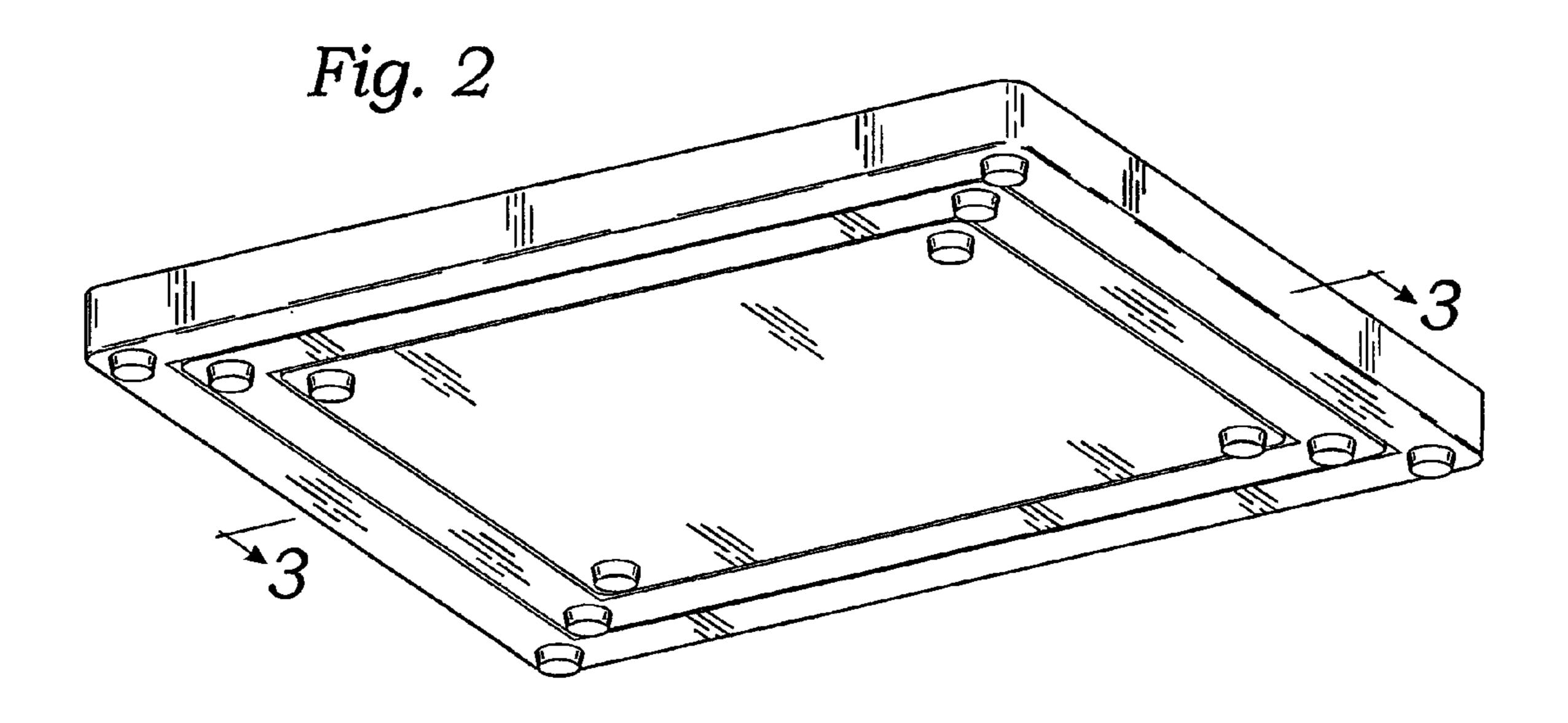


Fig. 3

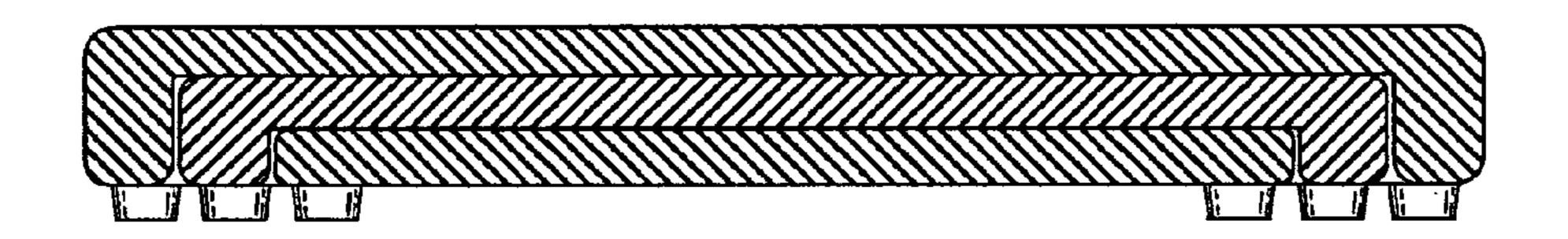


Fig. 4

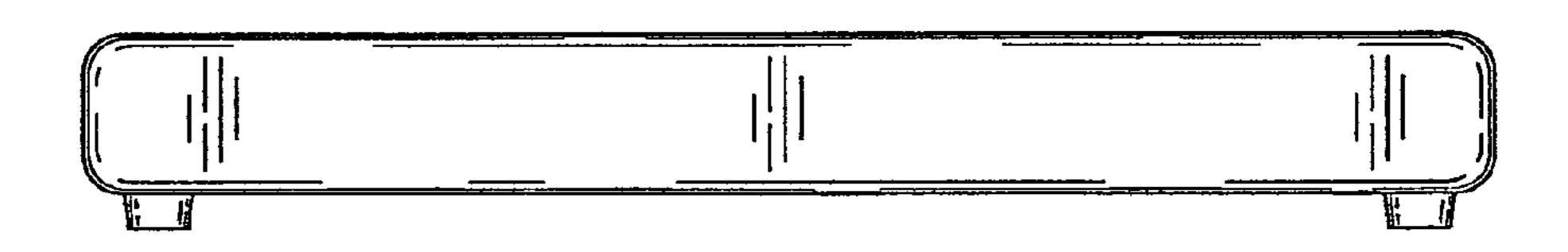


Fig. 5

